SPECIFICATIONS:

Insulation Resistance: $500M\Omega$ min. at 500V DC Withstanding Voltage: 250Vrms for 1min

Voltage Rating: 5Vrms DC Current Rating: 0.5A

Contact Resistance: 100mΩ max. at 20mV max.

Operating Temp.: - 25°C ~ +85°C

Mating Cycle: 5,000 times

MATERIALS AND FINISH:

• Contacts: Ni-Au/SnCu Alloy

· Insulator: LCP

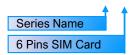
· Metal Shell: Stainless Steel

FEATURES:

- Tray type card mechanism
- Card Tray PN: FMA006-3800-0
- Reverse SMT Mount
- · RoHS and REACH Compliant

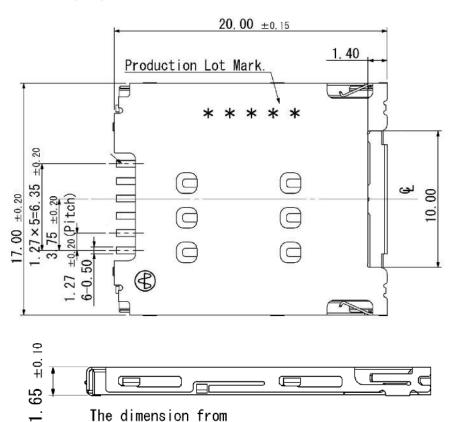
PART NUMBER:

FMS006-3810-0





OUTLINE DIMENSIONS (mm):



the bottom of solder terminal to the top of the connector.